

A	201808			

B      2020-10-29      7      5A1P30      3411

**/ Descriptions**

SOT23-6 P MOS  
P-channel MOSFET in a SOT23-6 Plastic Package

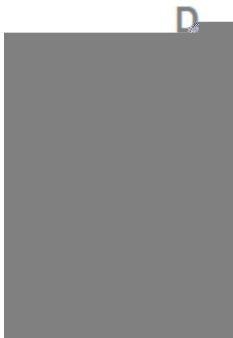
**/ Features**

$V_{DS}(V) = -30V$   
 $I_D = -4.2A (V_{GS} = -10V)$   
 $R_{DS(ON)} < 50m\Omega (V_{GS} = -10V)$   
 $R_{DS(ON)} < 65m\Omega (V_{GS} = -4.5V)$

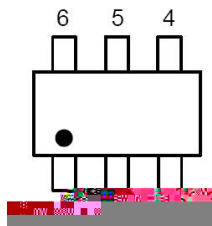
**/ Applications**

This device is suitable for use as a load switch or in PWM applications.

**/ Equivalent Circuit**



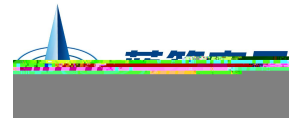
**/ Pinning**



PIN 1 D    PIN 2 D    PIN 3 G    PIN 4 S    PIN 5 D    PIN 6 D

**/ Marking**

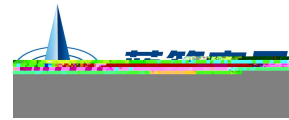
See Marking Instructions

/ Absolute Maximum Ratings( $T_a=25$  )

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Drain-Source Voltage	$V_{DSS}$	-30	V
Drain Current – Continuous	$I_D(T_a=25^\circ\text{C})$	-4.2	A
Drain Current- Continuous <sup>A</sup>	$I_D(T_a=70^\circ\text{C})$	-3.5	A
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	-30	A
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Maximum Power Dissipation <sup>A</sup>	$P_D(T_a=25^\circ\text{C})$	1.4	W
Total Power Dissipation <sup>A</sup>	$P_D(T_a=70^\circ\text{C})$	1.0	W
Maximum Junction-to-Ambient <sup>(Note 1)</sup>	$R_{JA}$	125	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	60	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ 150	$^\circ\text{C}$

/ Electrical Characteristics( $T_a=25$  )

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V$ $I_D=-250\mu A$	-30			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=-24V$ $V_{GS}=0V$ $T_j=25^\circ\text{C}$			-1	$\mu A$
		$V_{DS}=-24V$ $V_{GS}=0V$ $T_j=55^\circ\text{C}$			-5	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V$ $V_{DS}=0V$			$\pm 0.1$	$\mu A$
On-State Drain Current	$I_{D(on)}$	$V_{GS}=-4.5V$ $V_{DS}=-5V$	-25			A
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=-250\mu A$	-1.0		-2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V$ $I_D=-4.2A$		37	50	m
	$R_{DS(on)}$	$V_{GS}=-10V$ $I_D=-4.2A$ $T_j=125^\circ\text{C}$			75	
	$R_{DS(on)}$	$V_{GS}=-4.5V$ $I_D=-4A$		58	65	
Forward Transconductance	$g_{FS}$	$V_{DS}=-5V$ $I_D=-5A$	7	11		S
Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V$ $I_S=-1A$		-0.75	-1.0	V

/ Electrical Characteristics( $T_a=25$  )

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Capacitance	$C_{iss}$	$V_{DS}=-15V$ $V_{GS}=0V$ $f=1MHz$		957		pF
Output Capacitance	$C_{oss}$			115		
Reverse Transfer Capacitance	$C_{rss}$			77		
Gate resistance	$R_g$	$V_{GS}=0V$ $V_{DS}=0V,$ $f=1MHz$		6		
Total Gate Charge	$Q_g$	$V_{GS}=-4.5V$ $V_{DS}=-15V$ $I_D=-4A$		9.4		nC
Gate Source Charge	$Q_{gs}$			2		
Gate Drain Charge	$Q_{gd}$			3		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=-10V$ $R_L=3.6$ $V_{DS}=-15V$ $R_{GEN}=6$		6.3		ns
Turn-On Rise Time	$t_r$			3.2		
Turn-Off Delay Time	$t_{d(off)}$			38.2		
Turn-Off Fall Time	$t_f$			12		
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F=-4A, di/dt=100A/\mu s$		20.2		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F=-4A, di/dt=100A/\mu s$		11.2		nC

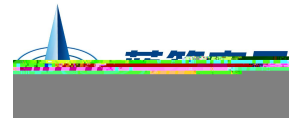
A: The value of  $R_{JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t_{10s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

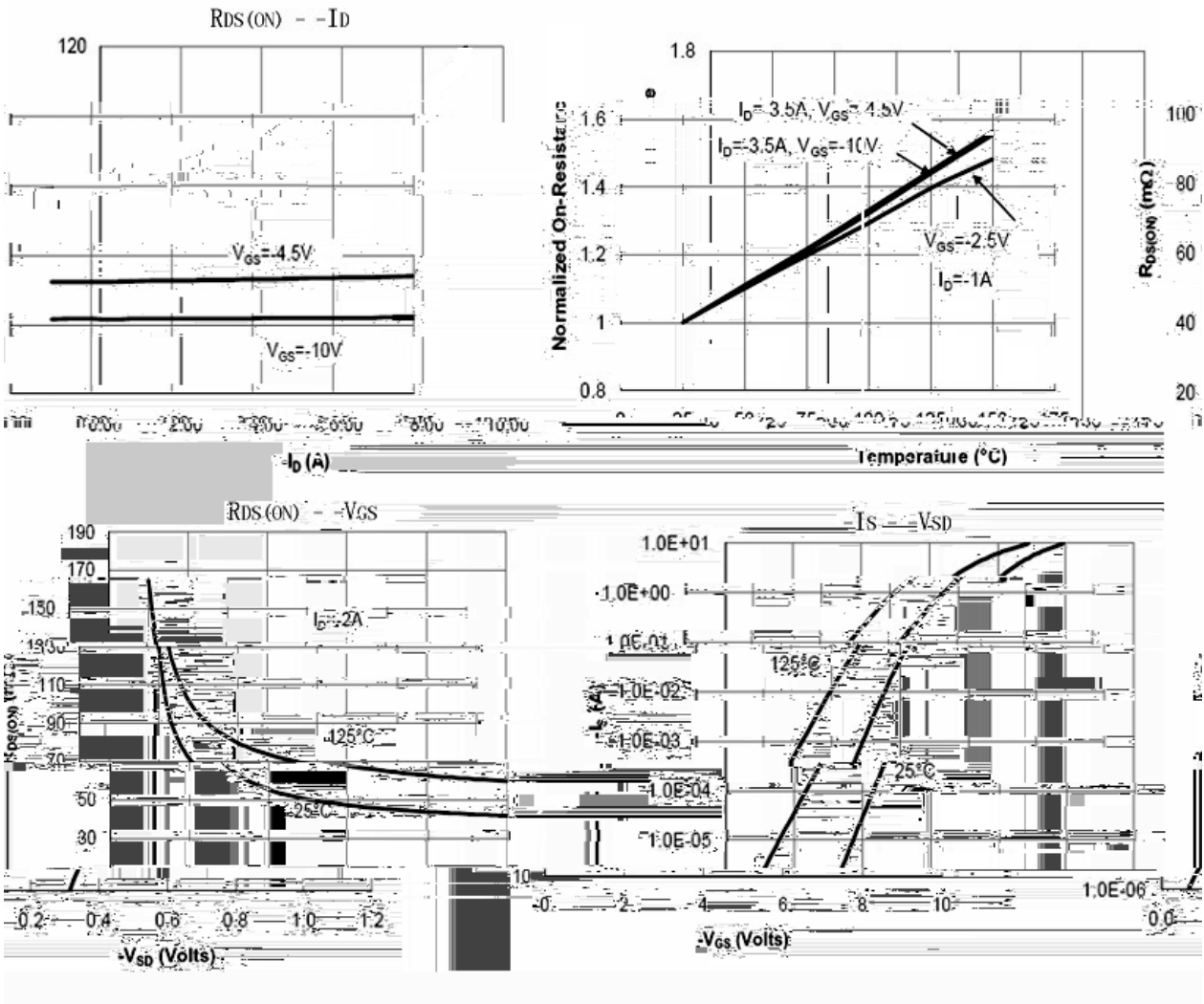
C. The  $R_{JA}$  is the sum of the thermal impedance from junction to lead  $R_{JL}$  and lead to ambient.

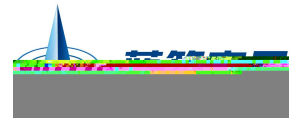
D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80  $\mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The SOA curve provides a single pulse rating.

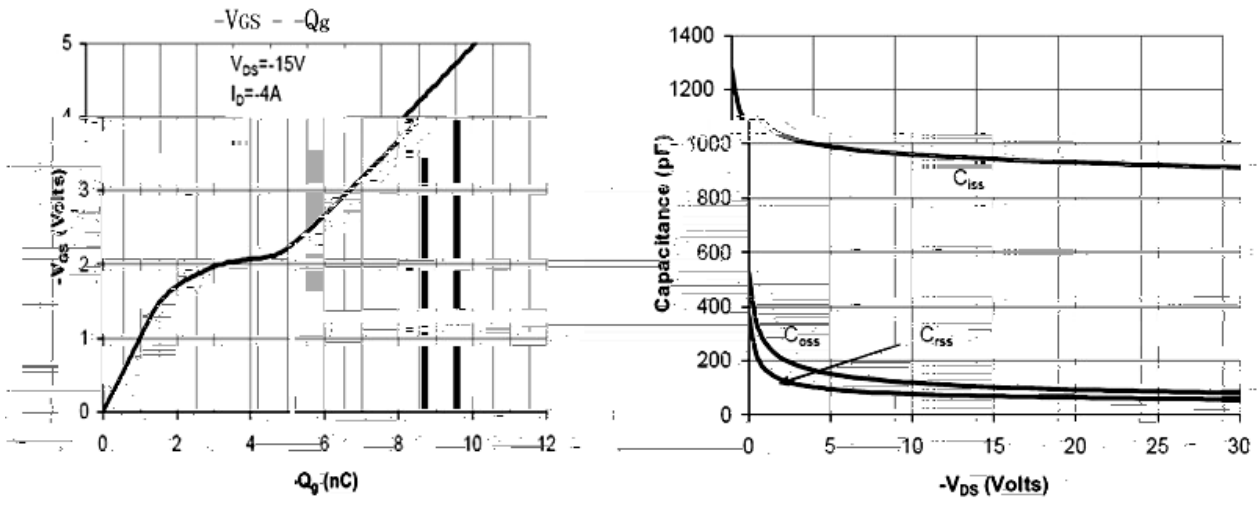


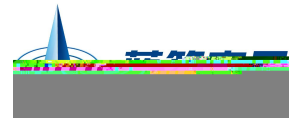
**/ Electrical Characteristic Curve**



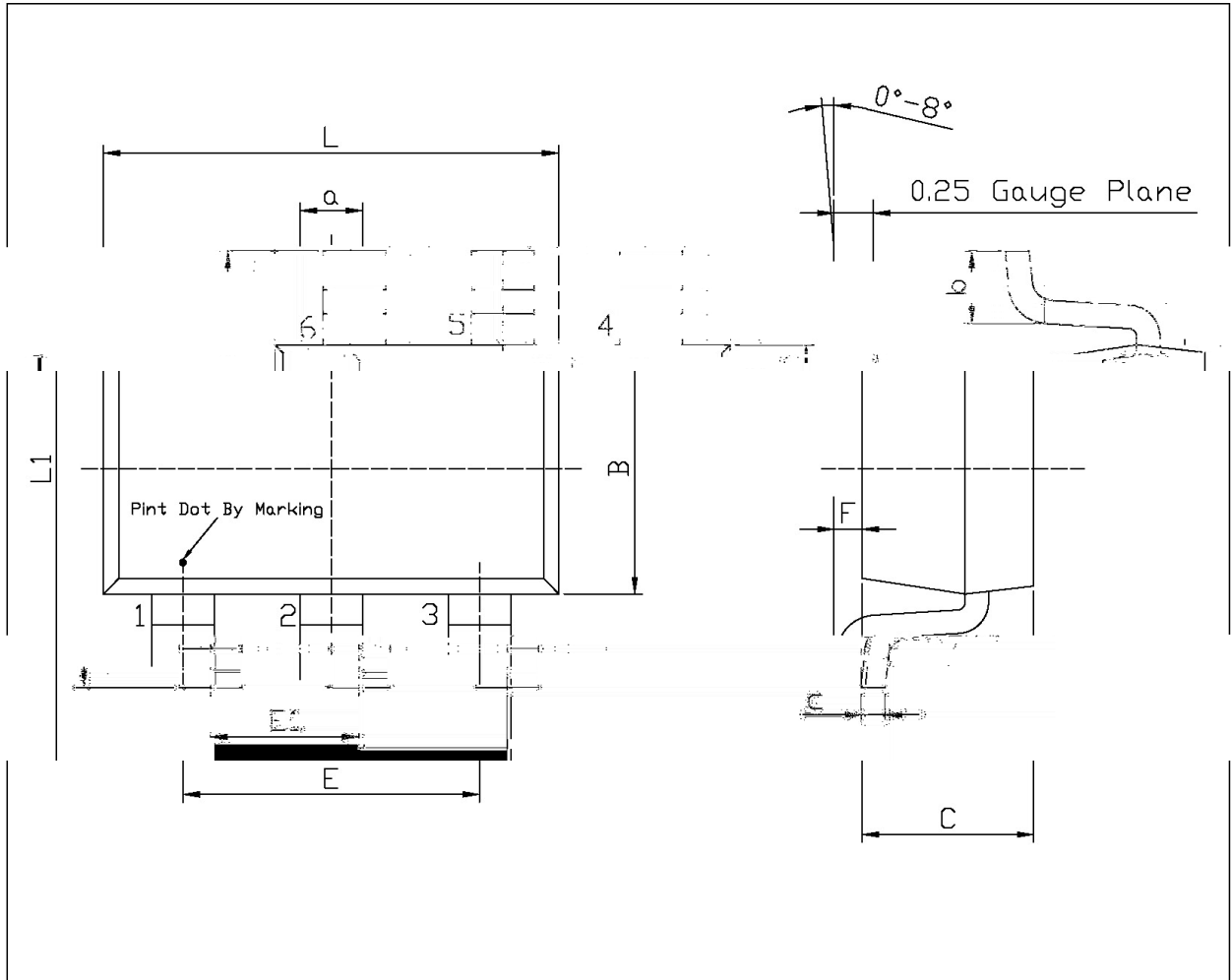


**/ Electrical Characteristic Curve**





**/ Package Dimensions**



Unit: mm

Symbol	Dimension	Min	Max	Symbol	Dimension	Min	Max
E1	0.80	0.80	1.15	L	5.82	5.82	6.02
			0.50	R	1.50	1.50	1.70
			0.20				0.30
			0.35				2.60
			0.15				1.80

